

Technical Data Sheet

# HYSOL<sup>®</sup> EE0149 EE1067 EE1068 –

## **Electronic Formulated Liquid**

HD3561

Formerly Dexter

## Room Temperature Cure, Flame -Out Casting Systems

EE0149/HD3561 Black EE1067/HD3561 Off White

EE1068/HD3561 Black

#### Description

Casting compounds EE0149 and EE1067 (EE1068) using hardener HD3561 have been formulated to meet the needs for flame-out, easily handled casting systems. The cured systems are non-burning or self-extinguishing according to ASTM D 635 and meet the U.L. requirements for 94V-0. EE1068 is the black version of EE1067.

EE0149 with hardener HD3561 is formulated to be a low cost casting system and is listed in Underwriter's Laboratory Component Index. EE0149 meets the requirements of UL 94V-0 in <sup>1</sup>/<sub>4</sub>" cross section and 94HB in 0.080" cross-section.

These products are recommended for potting modules. Modules potted in EE1067 with HD3561 have been used over the temperature range of  $+130^{\circ}$ C to  $-65^{\circ}$ C ( $+266^{\circ}$ F to  $-85^{\circ}$ F).

Typical Uncured Properties	EE0149	EE1067/HD3 EE1068	561 Test N	<b>lethod</b>
Color	Black	Off white/ Black	Amber	Visual
Filler content, %	51	40	0	STP 3A
Specific Gravity @ 25°C (77°F)	1.56	1.65	1.01	STP 9A
Viscosity @ 25°C (77°F)				STP 2A
Brookfield RVF				
Spindle 5, Speed 10 cps	17,000			
Spindle 6, Speed 20 cps		30,000		
Spindle 1, Speed 20, cps, max			20	
Shelf Life @ 25°C (77°F), months				
min. from date of shipment	6	6	12	
Solids Content, %	100	100	100	

Typical Cured Properties - Values are not intended for use in preparation of specifications. All measurements are taken at 25°C (77°F) unless otherwise noted.

### **Cured Physical Characteristics**

		EE1067/		
	EE0149	EE1068/Test		
	/HD3561	/HD3561	Method	
Color	Black	Off White/	Visual	
		Black		
Coefficient of linear thermal expansion			STP65B	
in/in/°C, (30° to 40°C) x 10 <sup>-6</sup>	57	70		
(110° to 130°C) x 10 <sup>-6</sup>	165	225		
Compressive strength, psi	11,800	12,600	STP 92A	
Density, gm/cc	1.54	1.59	STP 9A	
Filler Content, %	45	34	STP 3A	
Flexural strength, psi	10,300	13,500	STP 39A	
Flammability	Pass	Pass	UL 94V-0	
Linear shrinkage, %	.47	0.10	STP 56C	
Moisture absorption			STP 109A	
(24 hr immersion), %	0.27	0.8		
Tensile strength, psi	4,970	6,600	STP 38A	
Thermal conductivity, @ 30°C			STP 47C	
(cal x cm/sec x cm <sup>2</sup> x $^{\circ}$ C) x 10 <sup>-4</sup>	12	8.7		
Hardness, Shore D	90	88	STP 11A	
Elongation, %	1.3	1.7	STP 38A	
Glass Transition Temperature, °C	48	50	STP 65B	

#### **Cured Electrical Properties**

Cured Electrical Properties		EE1067/	
	EE0149	EE1068/Test	t
	/HD3561	/HD3561	Method
Dielectric strength @ 10 mil thickness			STP 48D
volts/mil	1285	1330	
Arc Resistance, seconds	134	97	STP 48E

	EE0149/HD3561			EE1067/EE1068/HD3561				
	25°C		85°C		25°C		85°C	
	К	D	K	D	K	D	K	D
100 Hz	4.8	.019	8.0	.233	4.7	.013	8.3	.088
1 kHz	4.7	.013	7.1	.077	4.7	.012	7.7	.048
10 kHz	4.6	.017	6.5	.057	4.6	.018	7.1	.067
Vol. Res.	5 x 10	15	2 x 10	12	$3 \times 10^{10}$	16	$4 \times 10^{10}$	2
Surf. Res.	4 x 10	15	1 x 10	12	$2 \times 10^{10}$	16	$1 \ge 10^{10}$	3

K = Dielectric constant by STP 53A

D = Dissipation factor by STP 53A Vol. Res. = Volume resistivity in ohm-cm by STP 31A Surf. Res. = Surface resistivity in ohms by STP 31A

Handling	EE0149/HD3561	EE1067/EE1068/ HD3561
Mix ratio, parts by weight	100/13	100/15
Mix Ratio, parts by volume	100/20	100/24.5
Pot life @ 25°C (77°F)		
(200 gram mass), hours	2	1.5
Viscosity @ 25°C (77°F)		
Brookfield RVF, cps	1,800	1,000
Peak Exothermic Temperature		
(115 gram mass), °C (°F)	75 (167)	53 (125)

#### **Cure Schedule**

Recommended cure	Three hours at 60°C (140°F)
Alternate cure	Two days at 25°C (77°F)

#### 09/2002

For additional information in the Americas, please contact one of the following locations:				
New York	Canada	Brazil		
TEL: 716.372.6300	TEL: 905.814.6511	TEL: 011.55.11.4143.7000		
FAX: 716.372.6864	FAX: 905.814.5391	FAX: 011.55.11.4143.7100		

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